



Product Change Notification

Change Notification #: 116241 - 01

Change Title: Intel® Server Board S7200AP,
Intel® Server Board S7200APL,
Intel® Server Compute Module HNS7200AP,
Intel® Server Compute Module HNS7200APL,
Intel® Server System LADMP2312KXXX41,
Intel® Server System LADMP2312KXXX42,
Intel® Server System LADMP2312KXXX43,
Intel® Server System LADMP2312KXXX44 ,
PCN 116241-01, Product Discontinuance,
End of Product Life
Reason for Revision: Adding four products

Date of Publication: May 07, 2018

Key Characteristics of the Change:

Product Discontinuance

Forecasted Key Milestones:

Product Discontinuance Program Support Begins:	April 30, 2018
Orders for Discontinued Products Become Non-Cancelable:	June 30, 2018
Last Product Discontinuance Order Date:	September 30, 2018
Last Product Discontinuance Shipment Date:	December 30, 2018

Description of Change to the Customer:

Reason for Revision: Adding four products

Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Intel is announcing the discontinuance of selected Intel® Chassis and systems as listed in the "Products Affected/Intel Ordering Codes" table below.

Intel will make best efforts to support all orders placed between the Non-Cancelable and Non-Returnable (NCNR) and the Last Product Discontinuance Order (LPDO) dates. Intel will discontinue builds on the LPDO date. After the LPDO date existing inventory is still orderable, under NCNR terms, and will be filled on a first come first served basis. Deliveries must be accepted within 90 days from the LPDO date.

Final purchase orders are non-cancelable and non-returnable, notwithstanding any conflicting terms in our quotes, purchase order acknowledgement or Distributor agreements.

Intel reserves the right to change the products because of material source restriction

Engineering and Support Guidance for Discontinued Products:

1. No new features enhancements should be expected, however Engineering Change Orders (ECOs) may be required during the extended life period to maintain supply lines (e.g. to qualify new vendor due to a component EOL).
2. Intel will provide reasonable commercial efforts in debugging issues during the warranty period for the product after the Product Discontinuance Announcement (PDA) date has passed. Fixes cannot be committed, but Intel will endeavor to provide reasonable workarounds for the product.

Customer Impact of Change and Recommended Action:

Determine your remaining demand for this product and/or evaluate additional sources (if applicable).

Lead-times on products with announced product discontinuance can typically stretch to 12 weeks and volumes are not buffered during the PDA period. Please work with your Intel representative on your quarterly demand forecast in order to reduce lead-times to 2-4 Weeks.

Please contact your local Intel Sales Office or Distributor if you require more information or need assistance in selecting a replacement product.

Milestone dates are estimates and subject to change based on business and operational conditions.

Products Affected / Intel Ordering Codes:

Marketing Name	Product Code	Affected MM#
Intel® Server Board S7200AP, OEM 10 Pack	BBS7200AP	942367
Intel® Server Board S7200APL, OEM 10 Pack	BBS7200APL	950090
Intel® Compute Module HNS7200AP, Single	HNS7200AP	942355
Intel® Compute Module HNS7200APL, Single	HNS7200APL	950091
Intel® Server System LADMP2312KXXX41	LADMP2312KXXX41	950477
Intel® Server System LADMP2312KXXX42	LADMP2312KXXX42	950501
Intel® Server System LADMP2312KXXX43	LADMP2312KXXX43	950504
Intel® Server System LADMP2312KXXX44	LADMP2312KXXX44	950505

PCN Revision History:

Date of Revision:	Revision Number:	Reason:
April 30, 2018	00	Originally Published PCN
May 7, 2018	01	Adding four products



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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